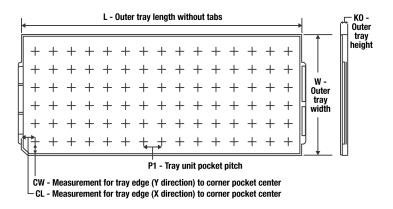


Carrier Material Report for TMS320DM643AZDK6

Tray Information:



Device	Package	Package	Pins	SPQ	Unit	Max	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW
	Drawing	Type			Array	Temp						(mm)
					Matrix	(°C)						
TMS32	ZDK	FCBGA	548	60	5 X 12	150	315	135.9	7620	25.5	17.25	16.95
0DM64												
3AZDK6												

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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